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To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

Eun Joo JANG; Shin Ae JUN; Hyo Sook JANG; Jung Eun LIM

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) 10/14/2008

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other _____

2. Name and address of receiving party(ies)

Name: Samsung Electronics Co., Ltd.

Internal Address: _____

Street Address: 416, Maetan-dong, Yeongtong-gu

Gyeonggi-do

City: Suwon-si

State: _____

Country: Republic of Korea Zip: 442-742

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Cantor Colburn LLP

Internal Address: _____

Street Address: 20 Church Street, 22nd Floor

City: Hartford

State: CT Zip: 06103

Phone Number: (860) 286-2929

Fax Number: (860) 286-0115

Email Address: cldavenport@cantorcolburn.com

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

- ☒ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

Deposit Account Number 061130

Authorized User Name Jae Y. Park

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01 FC:8021

Nov 7, 2008
Date

9. Signature:

Signature

Jae Y. Park

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 3

ASSIGNMENT

WHEREAS We, **Eun Joo JANG** of 301-1605, Dongsuwon LG Village 3 Cha, Mangpo-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, 443-773 Republic of Korea; **Shin Ae JUN** of 103-604, Kkachi Maeul 1 Danji Lotte Apt., Gumi-dong, Bundang-gu, Seongnam-si, Gyeonggi-do 463-500 Republic of Korea; **Hyo Sook JANG** of 125-405, Sibeomdanji Hanshin Apt., Seohyeon-dong, Bundang-gu, Seongnam-si, Gyeonggi-do 463-772 Republic of Korea; **Jung Eun LIM** of Samsung Advanced Institute of Technology, Mt. 14-1, Nongseo-dong, Giheung-gu, Yongin-si, Gyeonggi-do, 449-712 Republic of Korea (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

LIGHT EMITTING DEVICE AND FABRICATION METHOD THEREOF

which claims priority to **Korean Application No. 10-2008-0041004**, filed on May 1, 2008, and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, **SAMSUNG ELECTRONICS CO., LTD.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Korea, having a place of business at **416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, 442-742 Republic of Korea**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that

the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 2008/10/14

Jang Eunjoo L.S.
Eun Joo JANG

Date: 2008/10/14

Shin Ae Jun L.S.
Shin Ae JUN

Date: 2008/10/14

Jang Hyosook L.S.
Hyo Sook JANG

Date: 2008/10/14

Lim Jung Eun L.S.
Jung Eun LIM